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DATA SHEET

SKY65009-70LF: 250 to 2500 MHz Linear Power Amplifier Driver

Applications

- UHF television, CATV, DBS
- TETRA radio
- GSM, GPRS, CDMA, WCDMA
- AMPS, PCS,DCS
- ISM band transmitters
- Fixed WCS
- WLAN, WiMAX
- RFID

Features

- Wideband frequency range: 250 to 2500 MHz
- High linearity OIP3: +40 dBm
- Output P1 dB > +25 dBm
- High efficiency: PAE 40%
- Single DC supply: 3.3 V or 5 V
- On-chip bias circuit
- Low power consumption
- SOT-89 (4-pin 2.4 x 4.5 mm) Pb-free, ROHS-compliant package (MSL1, 260 °C per JEDEC J-STD-0-20)



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.

Description

Skyworks SKY65009-70LF is a high-performance, ultra-wideband power amplifier (PA) driver with superior output power, noise figure, linearity, and efficiency. The high linearity and superior adjacent channel power rejection/adjacent channel leakage ratio (ACPR/ACLR) performance make the SKY65009-LF ideal for use in the driver stage of infrastructure transmit chains.

The SKY65045-70LF is fabricated with Skyworks high-reliability Aluminum (Al) Gallium Arsenide (GaAs) Heterojunction Bipolar Transistor (HBT) process, which allows for single-supply operation while maintaining high efficiency and good linearity. The device uses low-cost surface-mount technology (SMT) in the form of a 2.4 x 4.5 mm small outline transistor (SOT-89) package.

The module can operate over a temperature range of -40 °C to +85 °C. A populated Evaluation Board is available upon request.

A functional block diagram is provided in Figure 1.

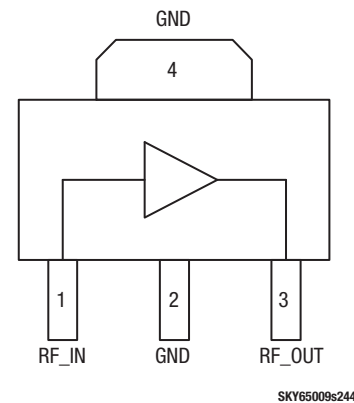


Figure 1. SKY65009-70LF Functional Block Diagram

Technical Description

The SKY65009-70LF is a single-stage, wideband PA in a low-cost surface-mount package. The device operates with a single 3 V or 5 V power supply connected through an RF choke (L1) to the output pin. Capacitors C7, C8, and C9 provide DC bias decoupling for VCC.

The bias current is set by the on-chip active bias composed of current mirror and reference voltage transistors, allowing for excellent gain tracking over temperature and voltage variations. The part is externally RF matched using surface mount components to facilitate operation over a frequency range of 250 MHz to 2500 MHz.

Pin 1 is the RF input and pin 3 is the RF output. External DC blocking is required for both input and output, but can be implemented as part of the RF matching circuit. Pin 2 and the package backside metal, pin 4, provide the DC and RF ground.

Electrical and Mechanical Specifications

Signal pin assignments and functional pin descriptions for the SKY65009 are provided in Table 1. The absolute maximum ratings are provided in Table 2, and the recommended operating conditions in Table 3. Electrical characteristics for the SKY65009 are provided in Table 4.

Typical performance characteristics of the SKY65009 are illustrated in Figures 2 through 92.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY65009 is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, Solder Reflow Information, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

Table 1. SKY65009 Signal Descriptions¹

| Pin | Name | Description |
|-----|--------|---------------|
| 1 | RF_IN | RF input |
| 2 | GND | Ground |
| 3 | RF_OUT | RF output/VCC |
| 4 | GND | Center ground |

¹ Center attachment pad must have low inductance and low thermal resistance connections to the customer's printed circuit board ground plane.

Table 2. SKY65009 Absolute Maximum Ratings
($T_A = +25\text{ }^\circ\text{C}$, Unless Otherwise Noted) ¹

| Parameter | Symbol | Value | Units |
|----------------------------------|------------------|-------------|-------|
| RF output power | P _{OUT} | +26 | dBm |
| Supply voltage | VCC | 6 | V |
| Supply current | I _{CC} | 300 | mA |
| Power dissipation | P _D | 1.1 | W |
| Operating case temperature range | T _C | -40 to +85 | °C |
| Storage temperature range | T _{ST} | -55 to +125 | °C |
| Junction temperature | T _J | 150 | °C |

¹ Performance is guaranteed only under the conditions listed in the specifications table and is not guaranteed under the full range(s) described by the Absolute Maximum specifications. Exceeding any of the absolute maximum/minimum specifications may result in permanent damage to the device and will void the warranty.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.

Table 3. SKY65009 Recommended Operating Conditions

| Parameter | Symbol | Min | Typical | Max | Units |
|---------------------------------------|-----------------|-----|---------|------|-------|
| Supply voltage | VCC | | 5 | 5.5 | V |
| Operating frequency | f _o | 100 | | 2500 | MHz |
| Operating case temperature | T _C | -40 | +25 | +85 | °C |
| Thermal resistance (junction to case) | θ _{JC} | | 20 | | °C/W |

Table 4. SKY65009 Electrical Characteristics¹ (1 of 3)
(VCC = 5.0 V, Output Impedance = 50 Ω, T_C = 25 °C, Unless Otherwise Noted)

| Parameter | Symbol | Test Conditions | Min | Typical | Max | Units |
|------------------------------------|------------------|--|-----|---------|-----|-------|
| <i>Test Frequency = 450 MHz</i> | | | | | | |
| Frequency | f | | | 450 | | MHz |
| Small signal gain | S ₂₁ | P _{IN} = -15 dBm | | 22 | | dB |
| Input return loss | S ₁₁ | Small signal | | 14.5 | | dB |
| Output return loss | S ₂₂ | Small signal | | 11.5 | | dB |
| 1 dB output compression point | OP1db | CW | | +26.8 | | dBm |
| Power-added efficiency | PAE | @ P1dB | | 38.5 | | % |
| Third order output intercept point | OIP3 | P _{IN} /tone = 0 dBm, Δf = 1 MHz | | +35 | | dBm |
| Noise figure | NF | P _{IN} = -15 dBm | | 6.5 | | dB |
| Quiescent current | I _{CCQ} | No RF | | 100 | | mA |

Table 4. SKY65009 Electrical Characteristics¹ (2 of 3)
(VCC = 5.0 V, Output Impedance = 50 Ω, Tc = 25 °C, Unless Otherwise Noted)

| Parameter | Symbol | Test Conditions | Min | Typical | Max | Units |
|------------------------------------|--------|---|------|---------|-----|-------|
| Test Frequency = 900 MHz | | | | | | |
| Frequency | f | | | 900 | | MHz |
| Small signal gain | S21 | Pin = -15 dBm | | 17 | | dB |
| Input return loss | S11 | Small signal | | 9 | | dB |
| Output return loss | S22 | Small signal | | 7.5 | | dB |
| 1 dB output compression point | P1db | CW | | +25.0 | | dBm |
| Power-added efficiency | PAE | @ P1dB | | 33 | | % |
| Third order output intercept point | OIP3 | Pin/tone = 0 dBm, Δf = 1 MHz | | +41 | | dBm |
| Power out @ ACPR = -45 dBc | ACPR | IS-95, 750 kHz offset | | 19 | | dBm |
| Noise figure | NF | Small signal | | 5 | | dB |
| Quiescent current | Iccq | No RF | | 100 | | mA |
| Test Frequency = 1960 MHz | | | | | | |
| Frequency | f | Best OIP3 match | | 1960 | | MHz |
| Small signal gain | S21 | Pin = -15 dBm | 10.5 | 12 | | dB |
| Input return loss | S11 | Small signal | | 19 | | dB |
| Output return loss | S22 | Small signal | | 10.5 | | dB |
| 1 dB output compression point | OP1db | CW | +26 | +27 | | dBm |
| Power-added efficiency | PAE | @ P1dB | 40 | 47 | | % |
| Third order output intercept point | OIP3 | Pin/tone = 0 dBm, Δf = 1 MHz | +37 | +42 | | dBm |
| Power out @ ACPR = -45 dBc | ACPR | IS-95, 885 kHz offset | +18 | +20 | | dBm |
| Noise figure | NF | Pin = -15 dBm | | 4.3 | 5.5 | dB |
| Quiescent current | Iccq | No RF | | 100 | 130 | mA |
| Test Frequency = 2140 MHz | | | | | | |
| Frequency | f | | | 2140 | | MHz |
| Small signal gain | S21 | Small signal | | 11.5 | | dB |
| Input return loss | S11 | Small signal | | 20 | | dB |
| Output return loss | S22 | Small signal | | 9.5 | | dB |
| 1 dB output compression point | OP1db | CW | | +26.7 | | dBm |
| Power-added efficiency | PAE | @ P1dB | | 48 | | % |
| Third order output intercept point | OIP3 | Pin/tone = 0 dBm, Δf = 1 MHz | | +42.5 | | dBm |
| Power out @ ACPR = -45 dBc | ACPR | 3G WCDMA, downlink 64 DPCH, 5 MHz offset | | +18 | | dBm |
| Noise figure | NF | Pin = -15 dBm | | 18 | | dB |
| Quiescent current | Iccq | Pin = -15 dBm | | 100 | | mA |

Table 4. SKY65009 Electrical Characteristics¹ (3 of 3)
(VCC = 5.0 V, Output Impedance = 50 Ω , Tc = 25 °C, Unless Otherwise Noted)

| Parameter | Symbol | Test Conditions | Min | Typical | Max | Units |
|------------------------------------|--------|---|-----|---------|-----|-------|
| <i>Test Frequency = 2450 MHz</i> | | | | | | |
| Frequency | f | | | 2450 | | MHz |
| Small signal gain | S21 | PIN = -15 dBm | | 10.3 | | dB |
| Input return loss | S11 | Small signal | | 22 | | dB |
| Output return loss | S22 | Small signal | | 15 | | dB |
| 1 dB output compression point | OP1db | CW | | +25.5 | | dBm |
| Power-added efficiency | PAE | @ P1dB | | 38.7 | | % |
| Third order output intercept point | OIP3 | PIN/tone = 0 dBm, $\Delta f = 1$ MHz | | +40 | | dBm |
| Noise figure | NF | Small signal | | 4.1 | | dB |
| Quiescent current | ICQ | PIN = -15 dBm | | 100 | | mA |

¹ Performance is guaranteed only under the conditions listed in this table.

Typical Performance Data

(VCC = 5 V, f = 450 MHz, CW, Output Impedance = 50 Ω, Tc = 25 °C, Unless Otherwise Noted)

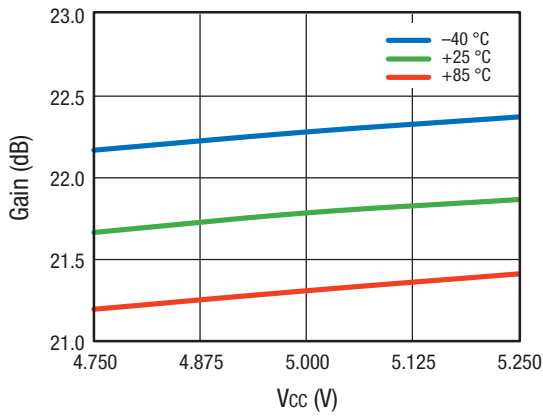


Figure 2. Gain vs VCC Across Temperature
Input Power = -15 dBm

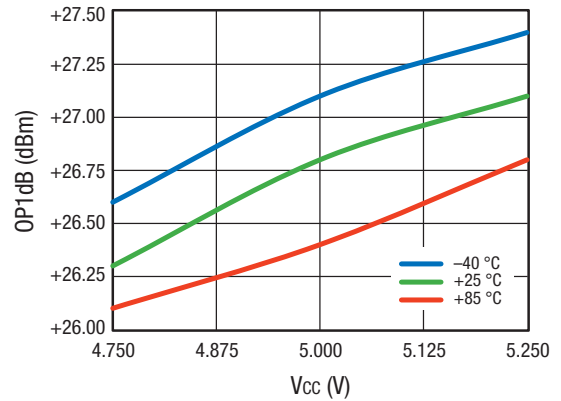


Figure 3. OP1 dB vs VCC Across Temperature

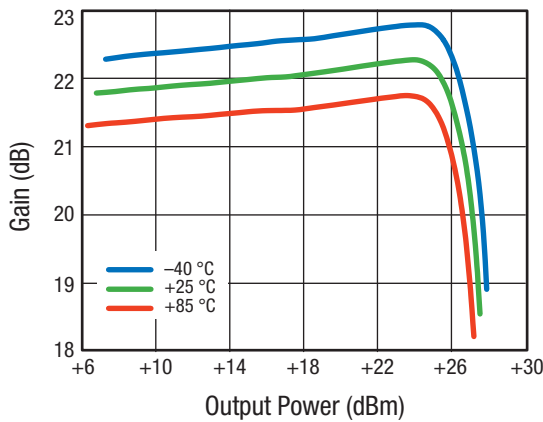


Figure 4. Gain vs Output Power Across Temperature

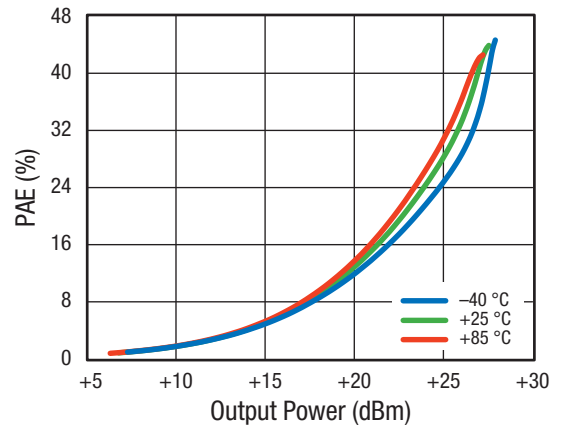


Figure 5. PAE vs Output Power Across Temperature

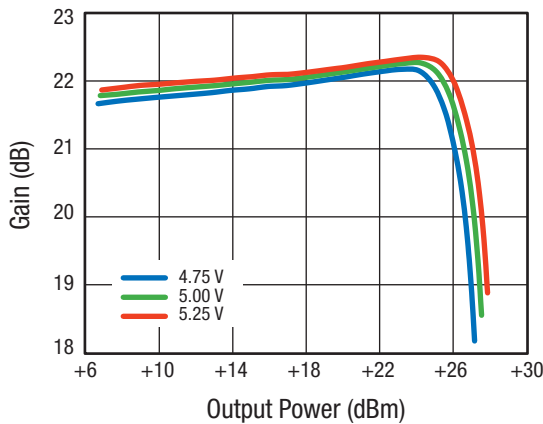


Figure 6. Gain vs Output Power Across Voltage

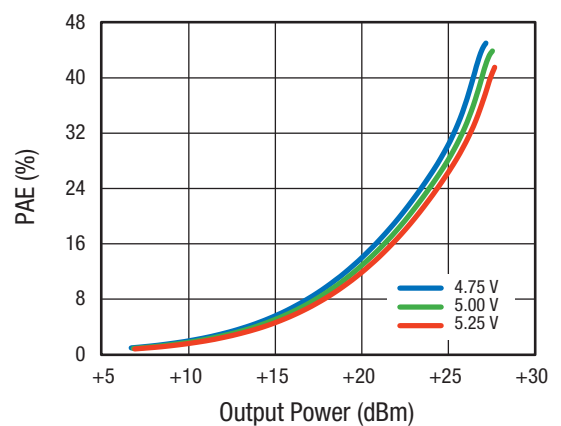


Figure 7. PAE vs Output Power Across Voltage

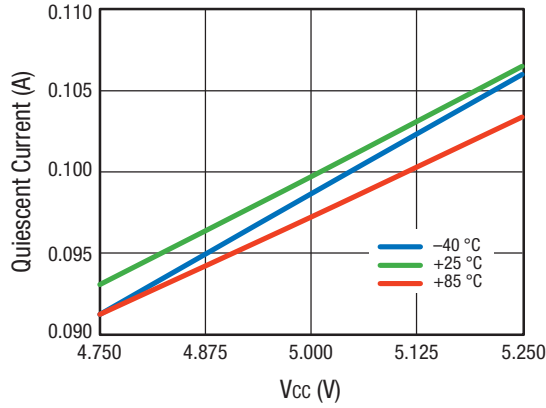


Figure 8. Quiescent Current vs VCC Across Temperature

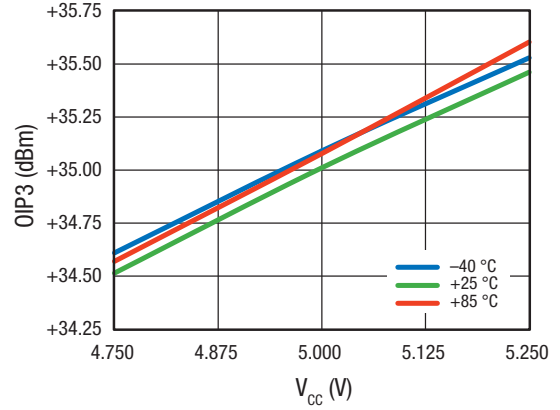


Figure 9. OIP3 vs VCC Across Temperature
Input Power/Tone = -5 dBm

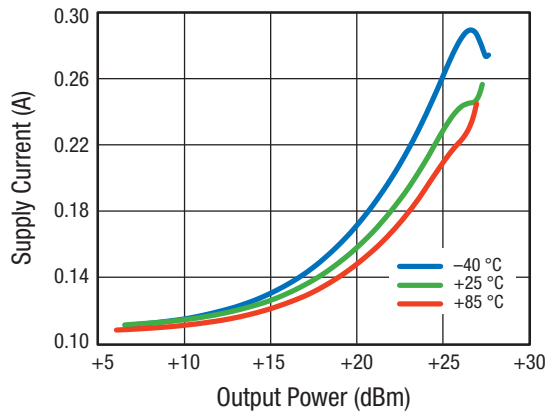


Figure 10. Supply Current vs Output Power Across Temperature

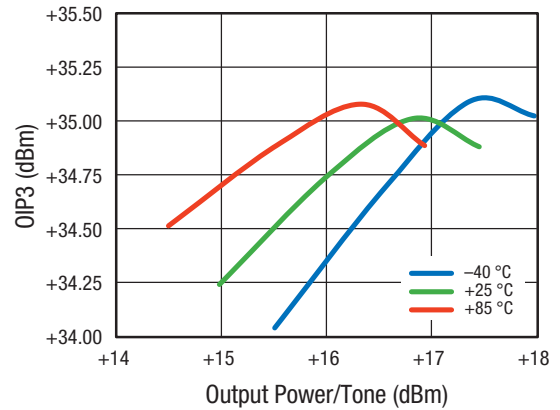


Figure 11. OIP3 vs Output Power/Tone Across Temperature

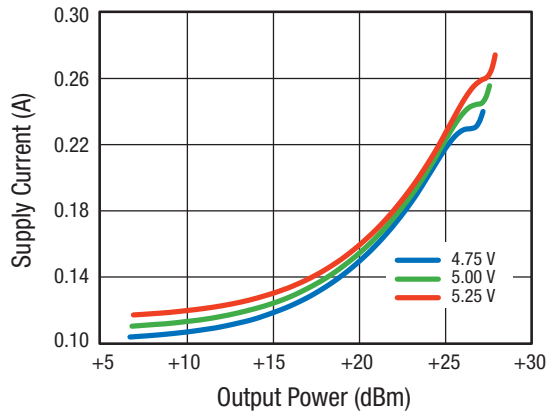


Figure 12. Supply Current vs Output Power Across Voltage

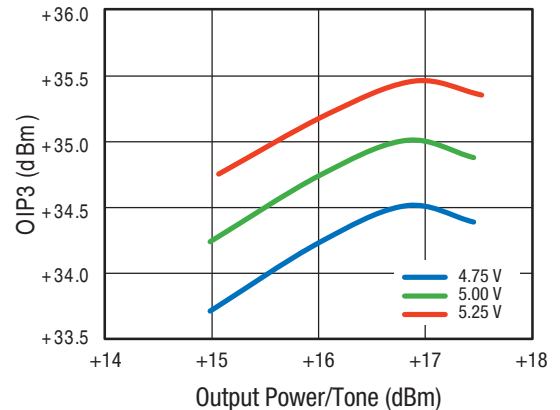


Figure 13. OIP3 vs Output Power/Tone Across Voltage

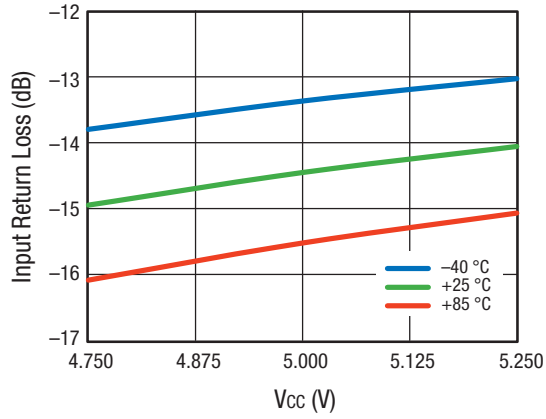


Figure 14. Input Return Loss vs VCC Across Temperature

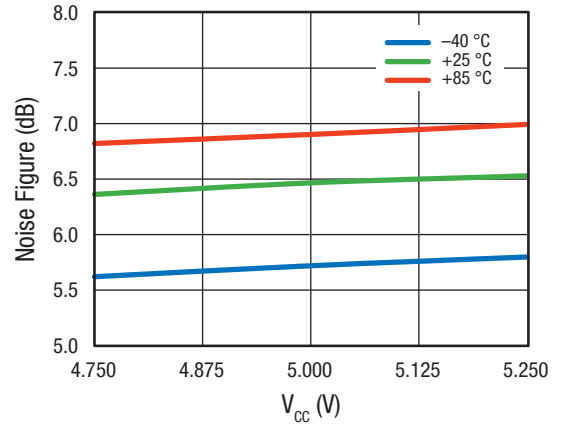


Figure 15. Noise Figure vs VCC Across Temperature

Typical Performance Data

(VCC = 5 V, f = 900 MHz, CW, Output Impedance = 50 Ω, Tc = 25 °C, Unless Otherwise Noted)

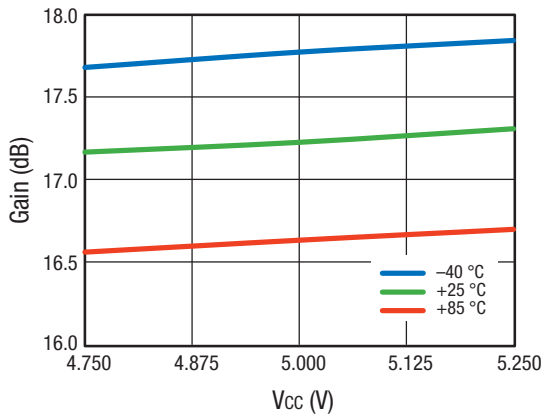


Figure 16. Gain vs VCC Across Temperature
Input Power = -15 dBm

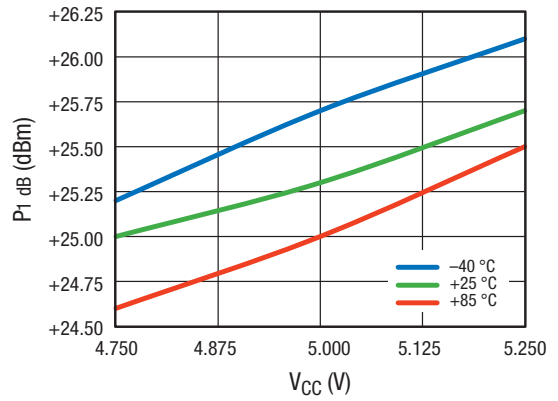


Figure 17. P1 dB vs VCC Across Temperature

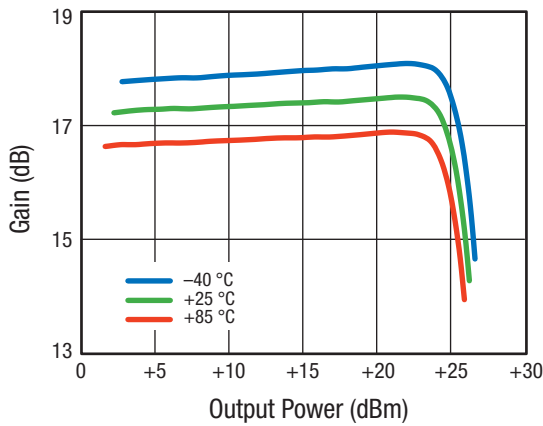


Figure 18. Gain vs Output Power Across Temperature

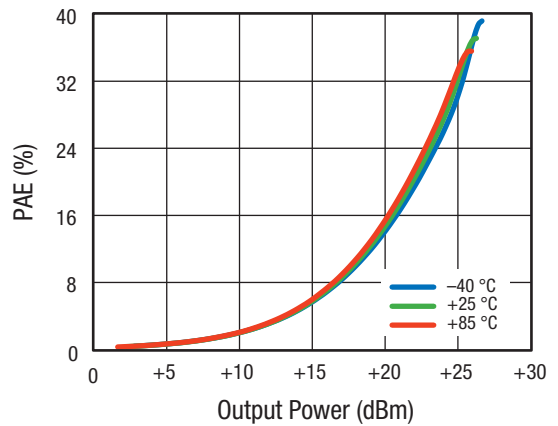


Figure 19. PAE vs Output Power Across Temperature

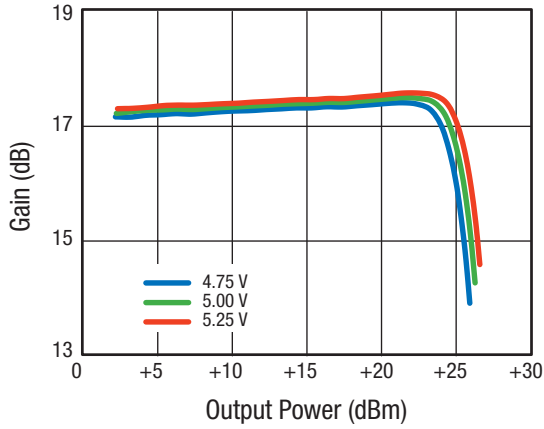


Figure 20. Gain vs Output Power Across VCC

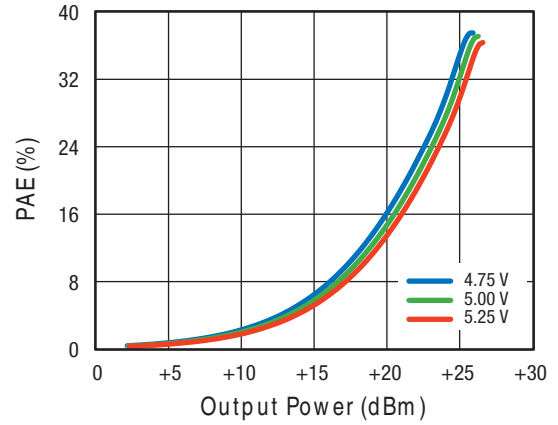


Figure 21. PAE vs Output Power Across VCC

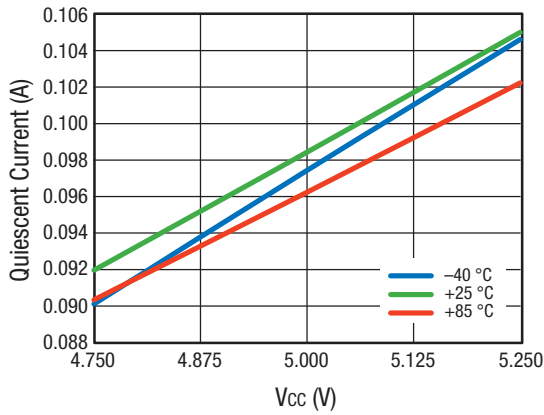


Figure 22. Quiescent Current vs VCC Across Temperature

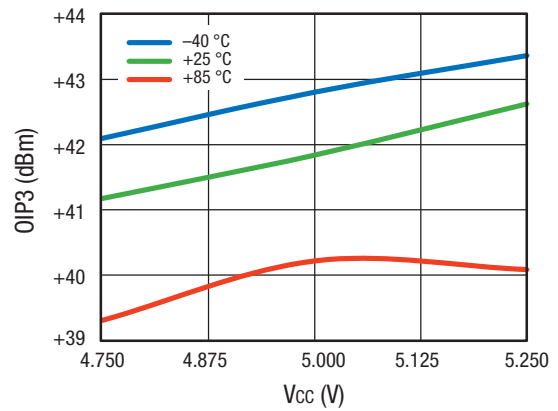


Figure 23. OIP3 vs VCC Across Temperature, Input Power/Tone = -2 dBm

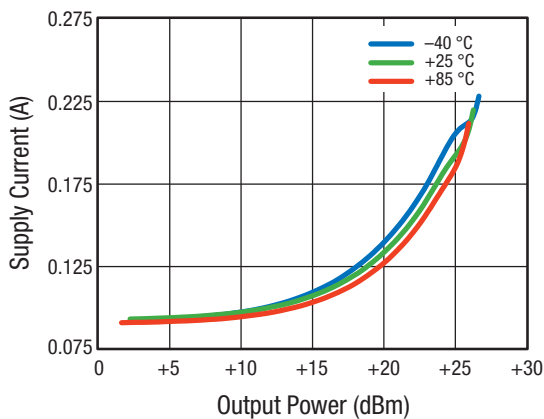


Figure 24. Supply Current vs Output Power Across Temperature

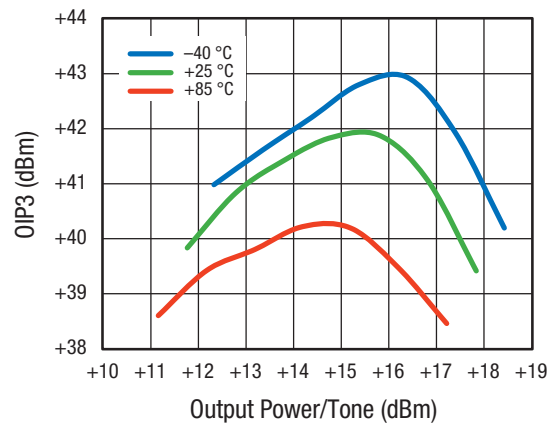


Figure 25. OIP3 vs Output Power/Tone Across Temperature

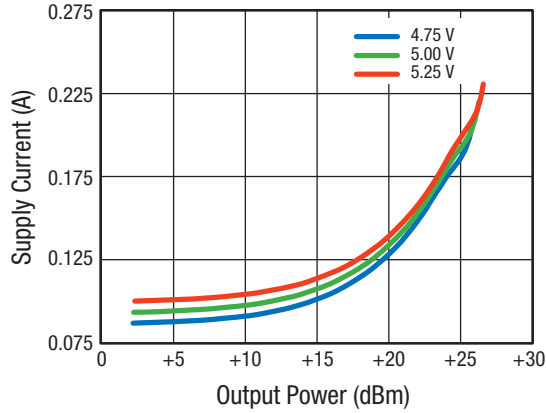


Figure 26. Supply Current vs Output Power Across VCC

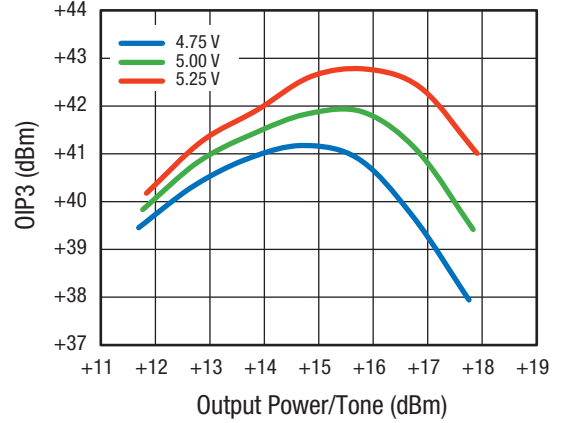


Figure 27. OIP3 vs Output Power/Tone Across VCC

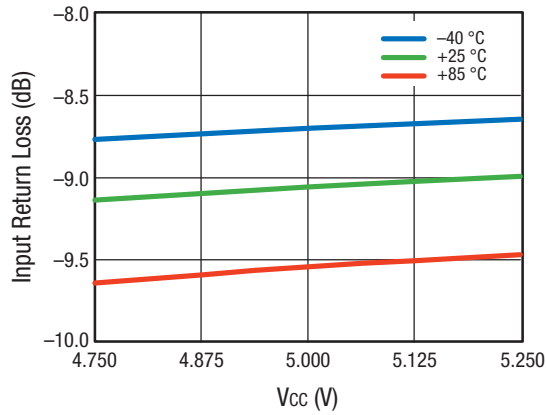


Figure 28. Input Return Loss vs VCC Across Temperature

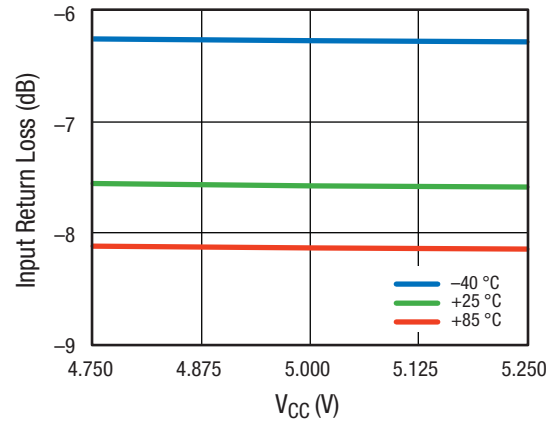


Figure 29. Input Return Loss vs VCC Across Temperature

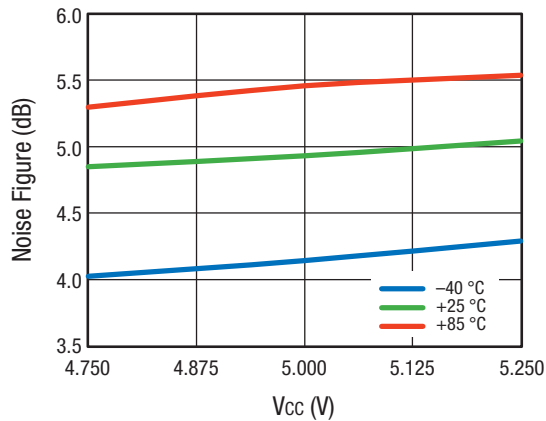


Figure 30. Noise Figure vs VCC Across Temperature

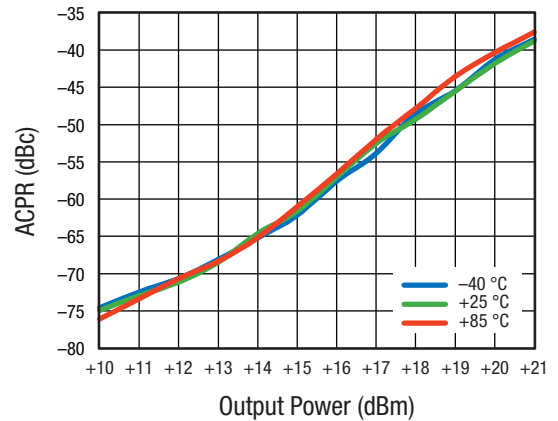


Figure 31. ACPR vs Output Power Across Temperature

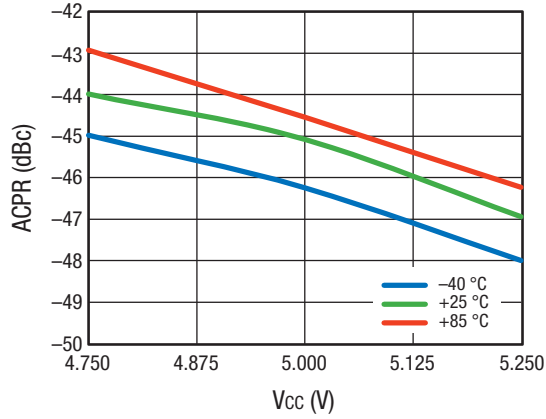


Figure 32. ACPR vs VCC Across Temperature @ Output Power = +19 dBm

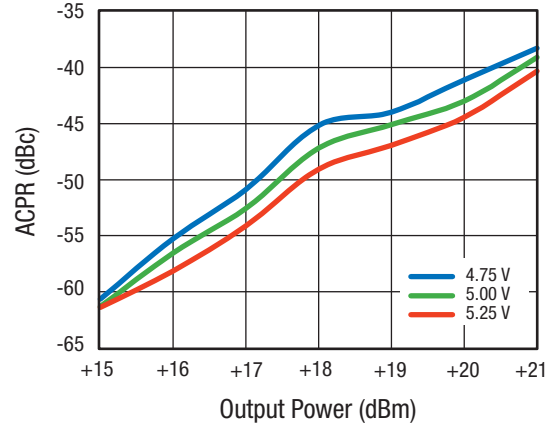


Figure 33. ACPR vs Output Power Across VCC

Typical Performance Data

(VCC = 5 V, f = 1960 MHz (Best OIP3 Match), CW, Output Impedance = 50 Ω, Tc = 25 °C, Unless Otherwise Noted)

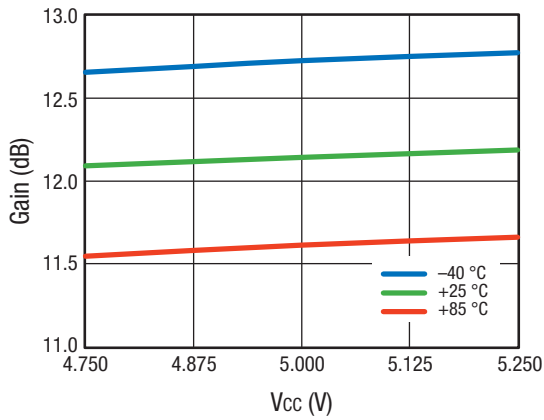


Figure 34. Gain vs VCC Across Temperature @ Input Power = -15 dBm

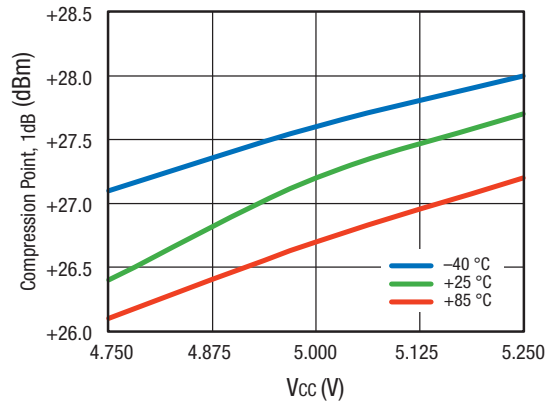


Figure 35. P1dB vs VCC Across Temperature

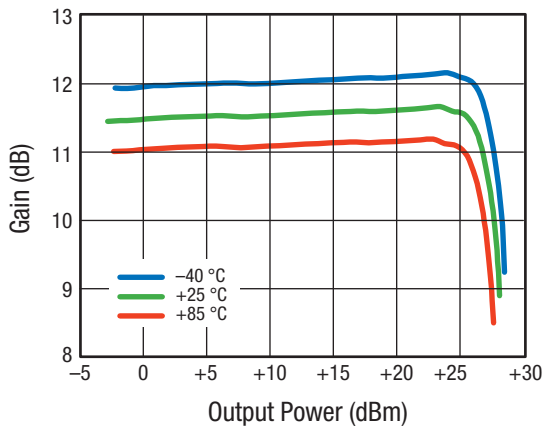


Figure 36. Gain vs Output Power Across Temperature

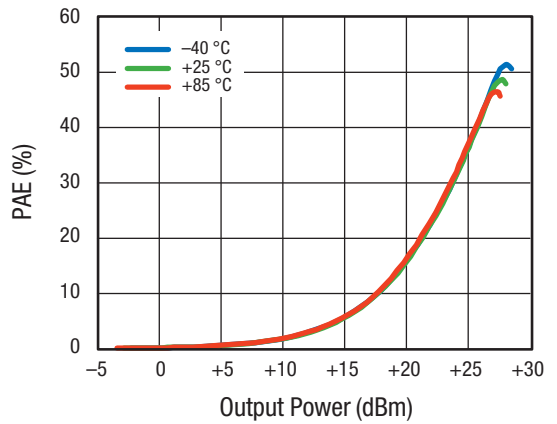


Figure 37. PAE vs Output Power Across Temperature

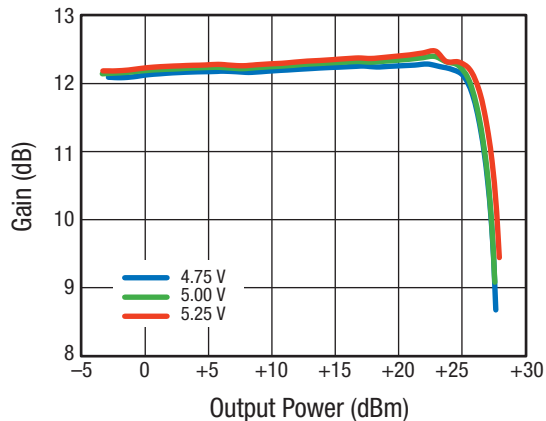


Figure 38. Gain vs Output Power Across VCC

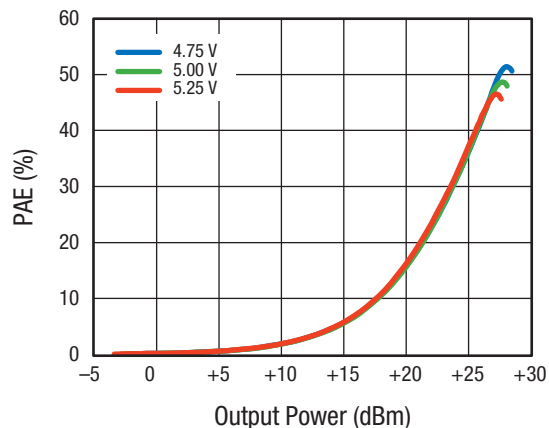


Figure 39. PAE vs Output Power Across VCC

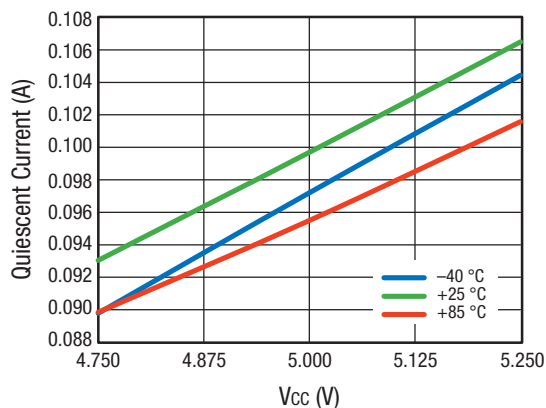


Figure 40. Quiescent Current vs VCC Across Temperature

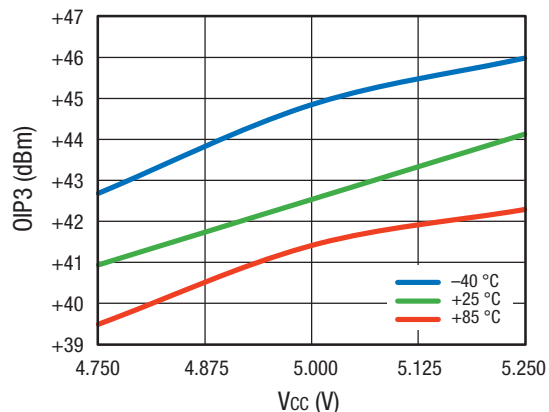


Figure 41. OIP3 vs VCC Across Temperature
Input Power/Tone = -1 dB

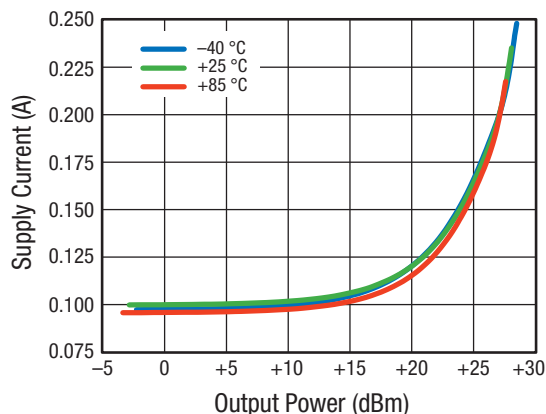


Figure 42. Supply Current vs Output Power Across Temperature

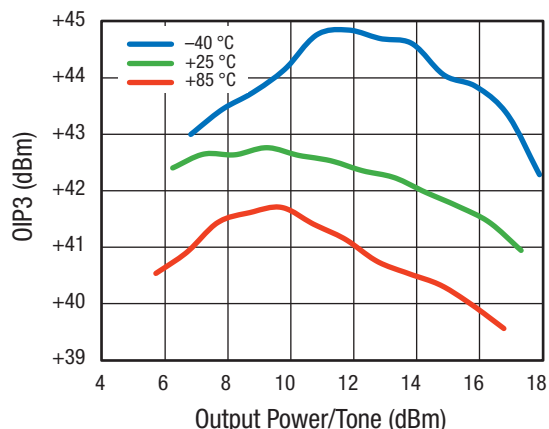


Figure 43. OIP3 vs Output Power/Tone Across Temperature

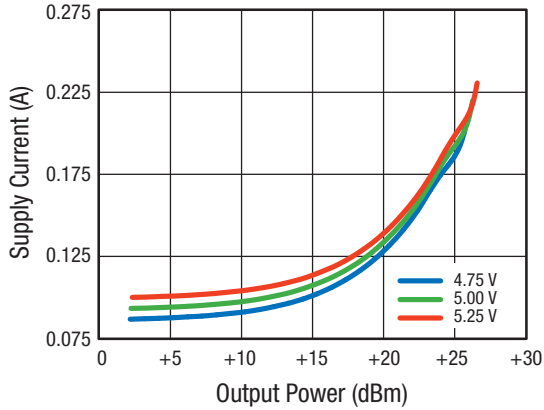


Figure 44. Supply Current vs Output Power Across VCC

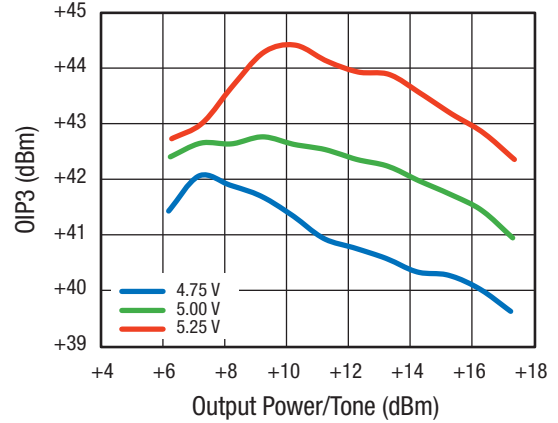


Figure 45. OIP3 vs Output Power/Tone Across VCC

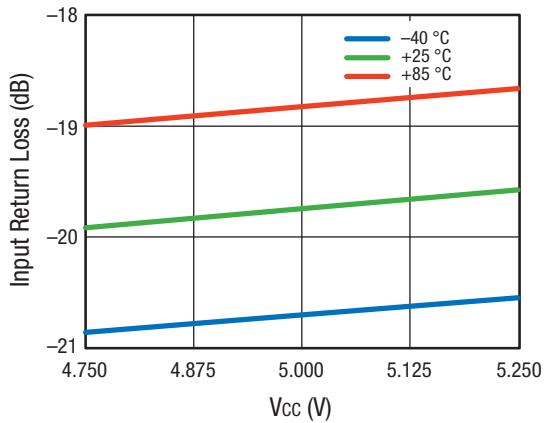


Figure 46. Input Return Loss vs VCC Across Temperature

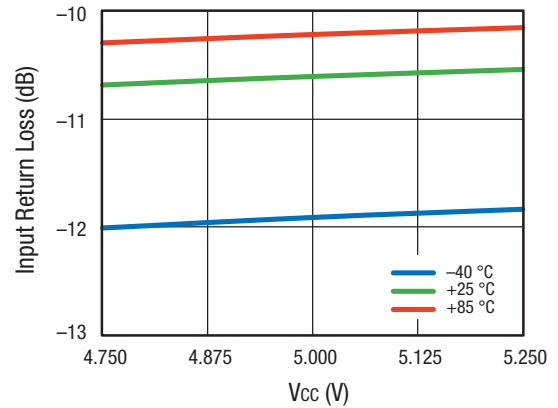


Figure 47. Input Return Loss vs VCC Across Temperature

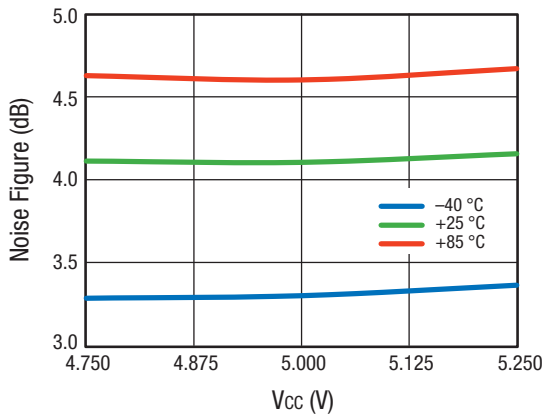


Figure 48. Noise Figure vs VCC Across Temperature

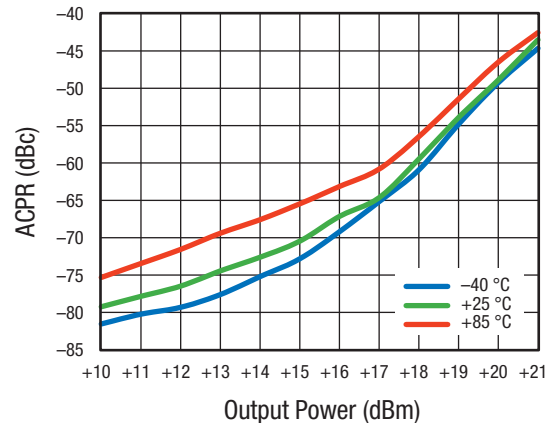


Figure 49. ACPR vs Output Power Across Temperature

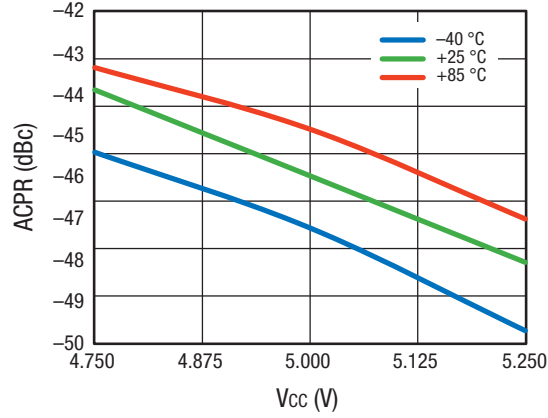


Figure 50. ACPR vs VCC Across Temperature
Output Power = 20 dBm

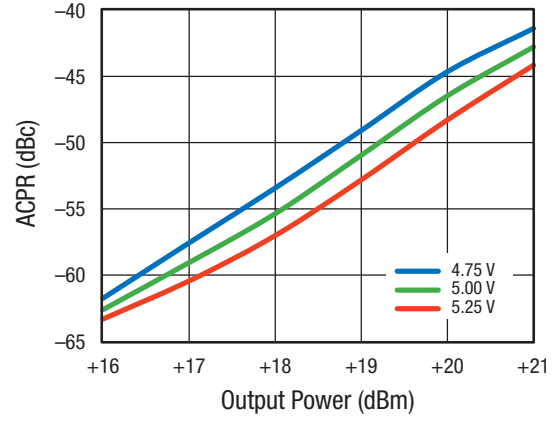


Figure 51. ACPR vs Output Power Across VCC

Typical Performance Data

(VCC = 5 V, f = 2140 MHz, CW, Output Impedance = 50 Ω, Tc = 25 °C, Unless Otherwise Noted)

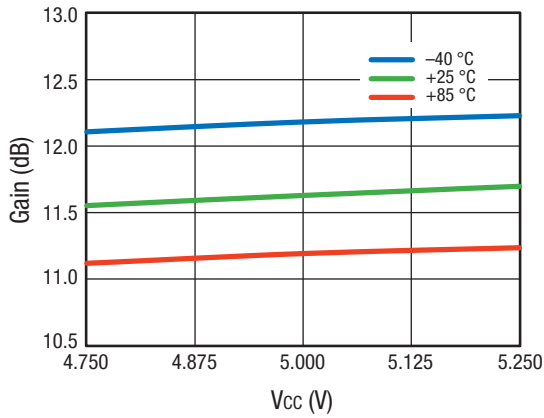


Figure 52. Gain vs VCC Across Input Power -15 dBm

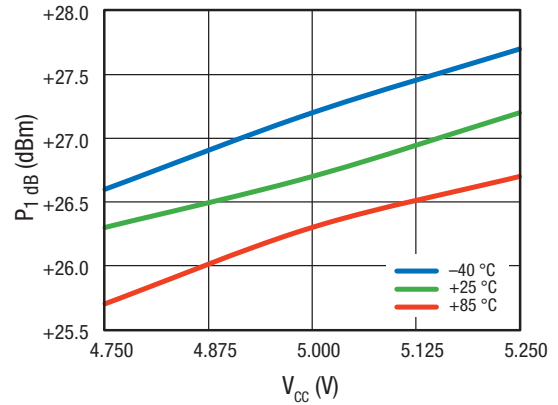


Figure 53. P1 dB vs VCC Across Temperature

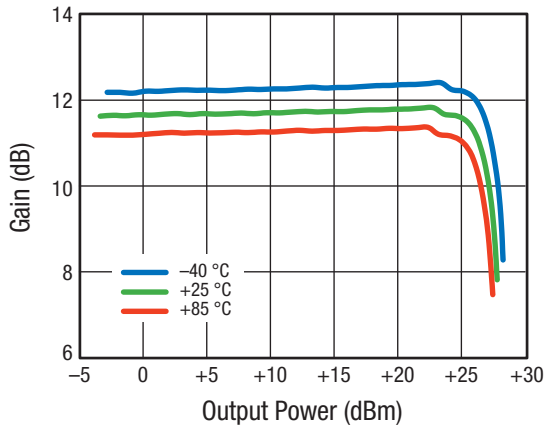


Figure 54. Gain vs Output Power Across Temperature

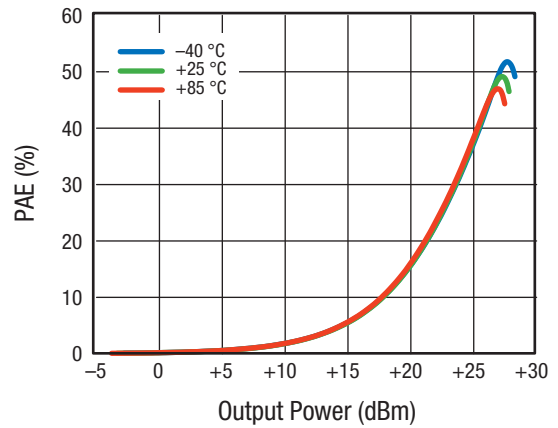


Figure 55. PAE vs Output Power Across Temperature

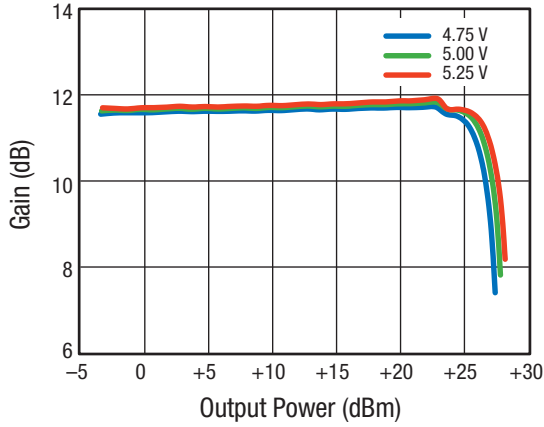


Figure 56. Gain vs Output Power Across VCC

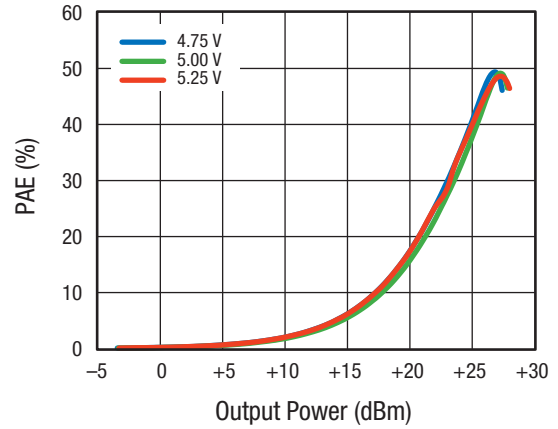


Figure 57. PAE vs Output Power Across VCC

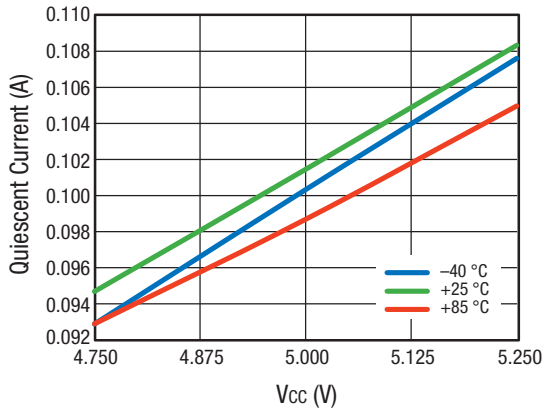


Figure 58. Quiescent Current vs VCC Across Temperature

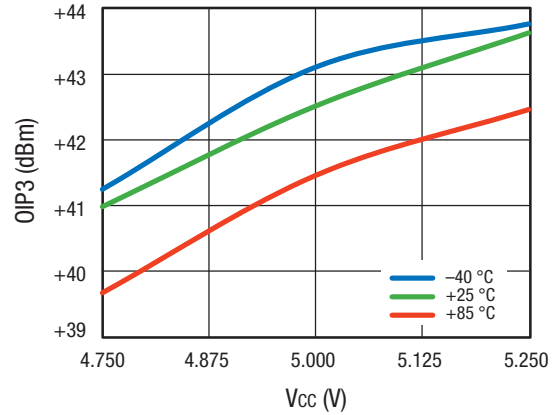


Figure 59. OIP3 vs VCC Across Temperature
Input Power/Tone = 0 dBm

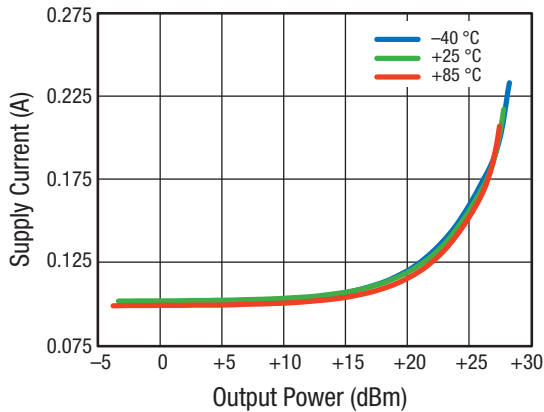


Figure 60. Supply Current vs Output Power Across Temperature

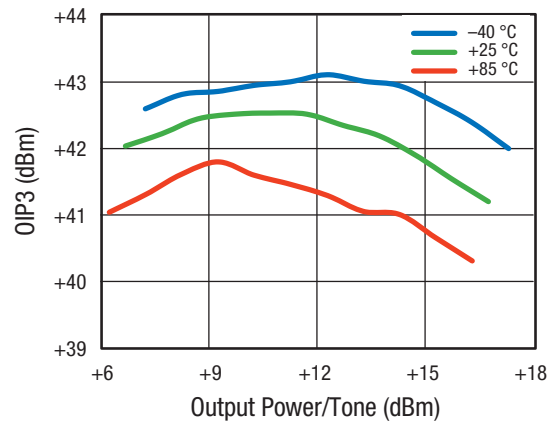


Figure 61. OIP3 vs Output Power/Tone Across Temperature

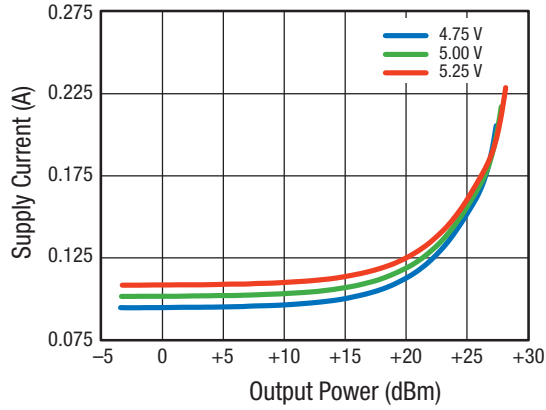


Figure 62. Supply Current vs Output Power Across VCC

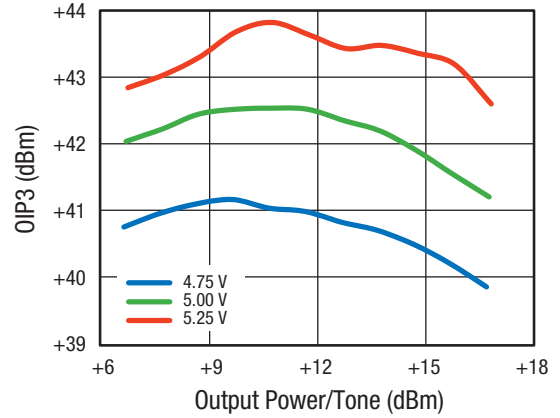


Figure 63. OIP3 vs Output Power/Tone Across VCC

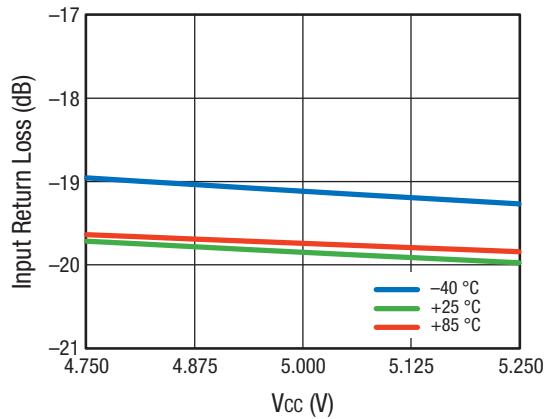


Figure 64. Input Return Loss vs VCC Across Temperature

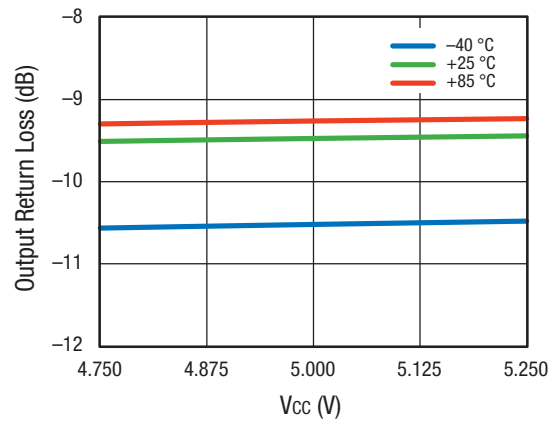


Figure 65. Output Return Loss vs VCC Across Temperature

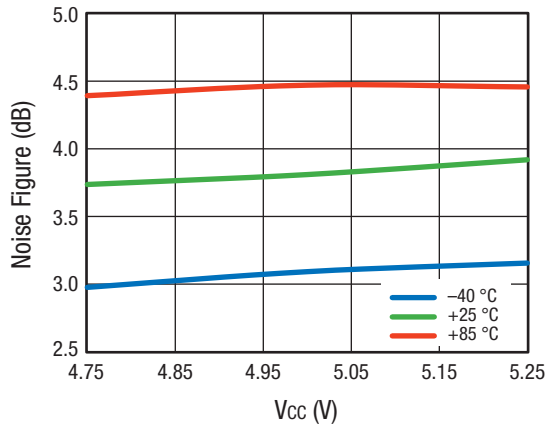


Figure 66. Noise Figure vs VCC Across Temperature

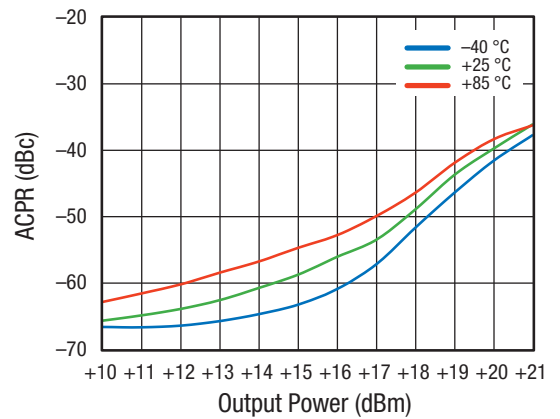


Figure 67. ACPR vs Output Power Across Temperature

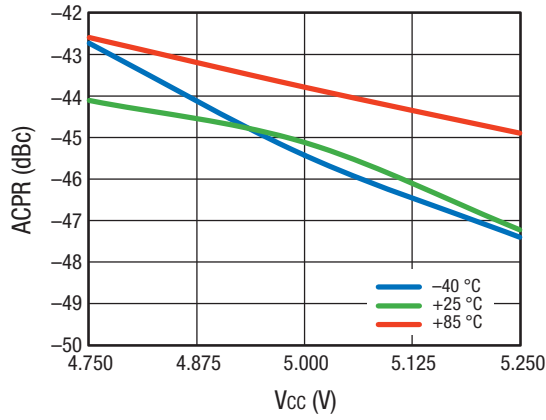


Figure 68. ACPR vs VCC Across Temperature
Output Power = +18 dBm

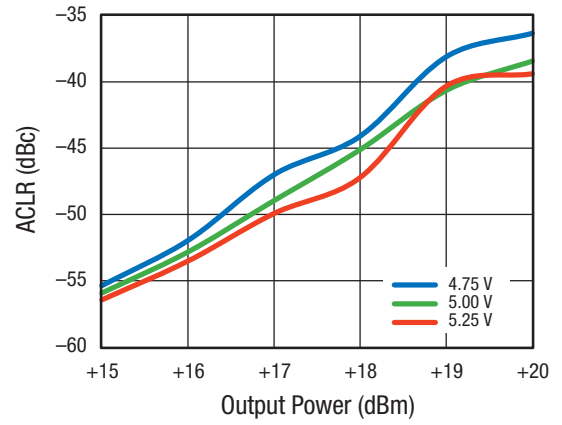


Figure 69. ACLR vs Output Power Across VCC

Typical Performance Data

(VCC = 5 V, f = 2450 MHz, CW, Output Impedance = 50 Ω, Tc = 25 °C, Unless Otherwise Noted)

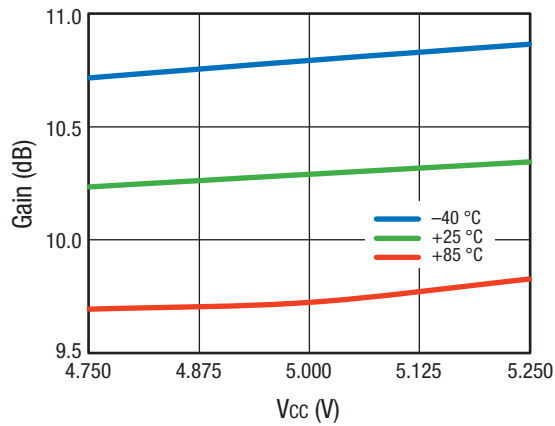


Figure 70. Gain vs VCC Across Temperature
Input Power = -15 dBm

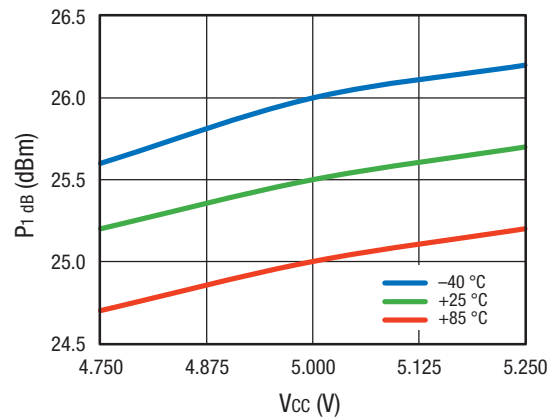


Figure 71. P1 dB vs VCC Across Temperature

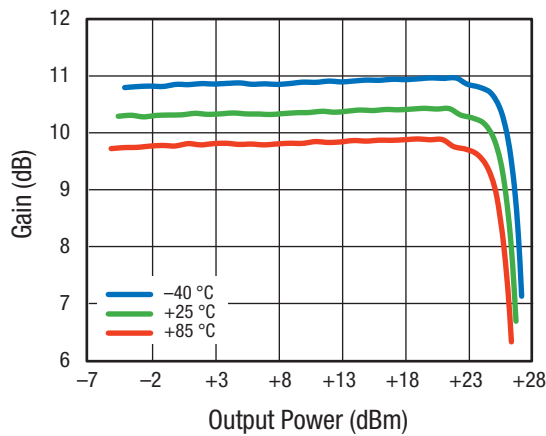


Figure 72. Gain vs Output Power Across Temperature

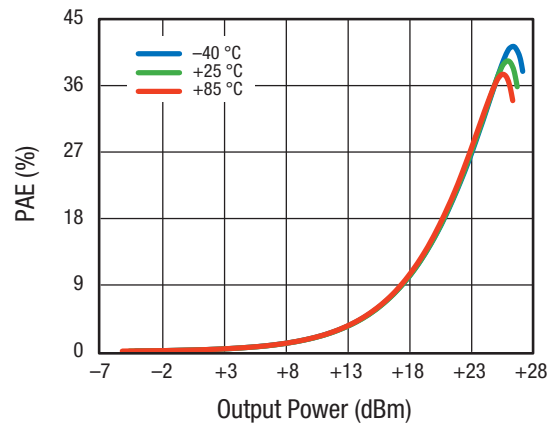


Figure 73. PAE vs Output Power Across Temperature

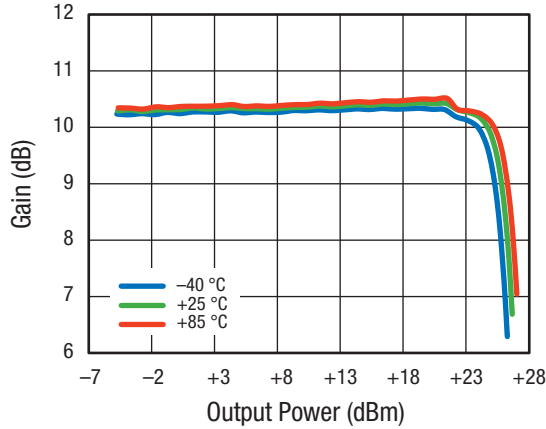


Figure 74. Gain vs Output Power Across VCC

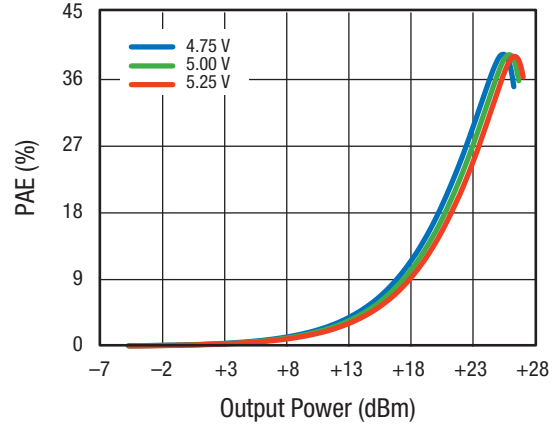


Figure 75. PAE vs Output Power Across VCC

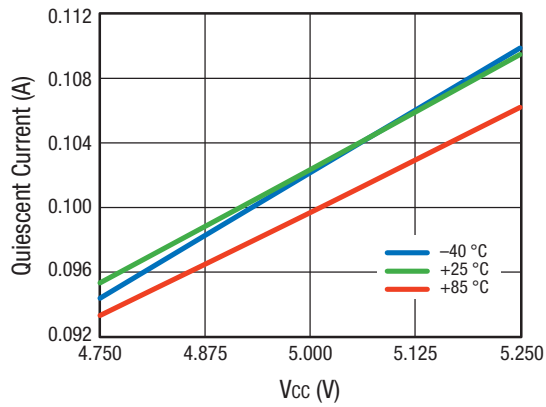


Figure 76. Quiescent Current vs VCC Across Temperature

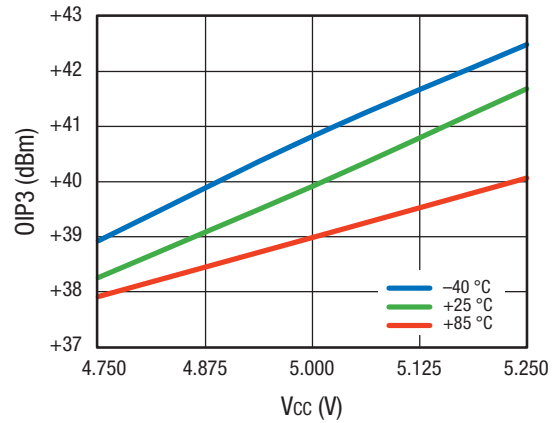


Figure 77. OIP3 vs VCC Across Temperature
Input Power/Tone = 0 dBm

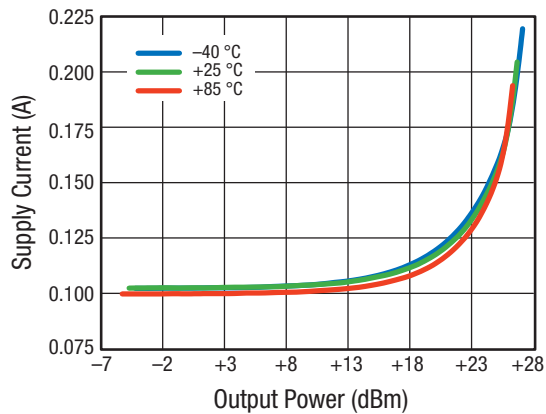


Figure 78. Supply Current vs Output Power Across Temperature

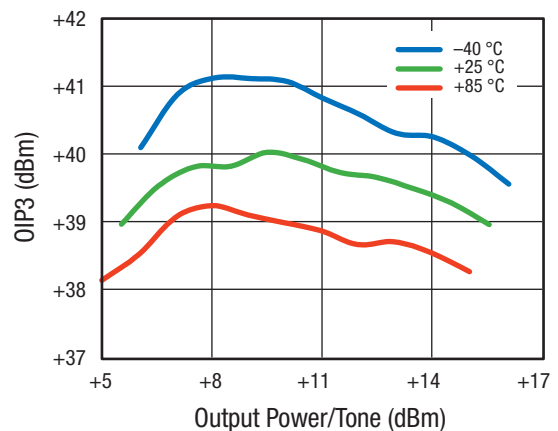


Figure 79. OIP3 vs Output Power/Tone Across Temperature

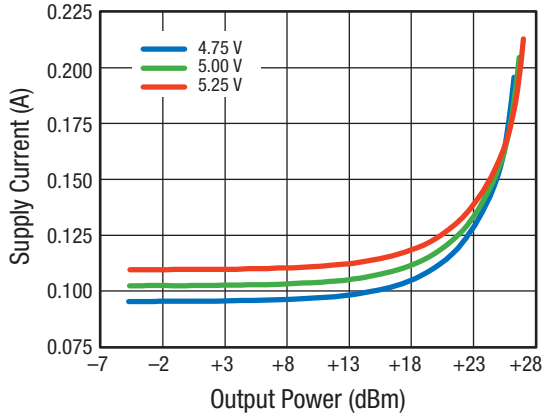


Figure 80. Supply Current vs Output Power Across VCC

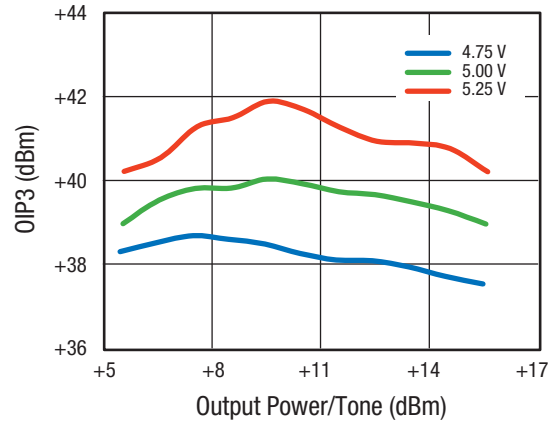


Figure 81. OIP3 vs Output Power/Tone Across VCC

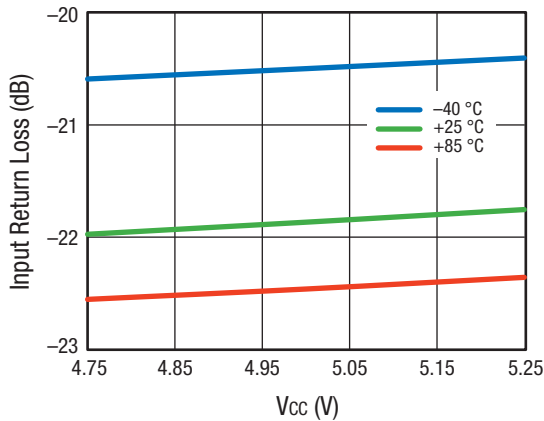


Figure 82. Input Return Loss vs VCC Across Temperature

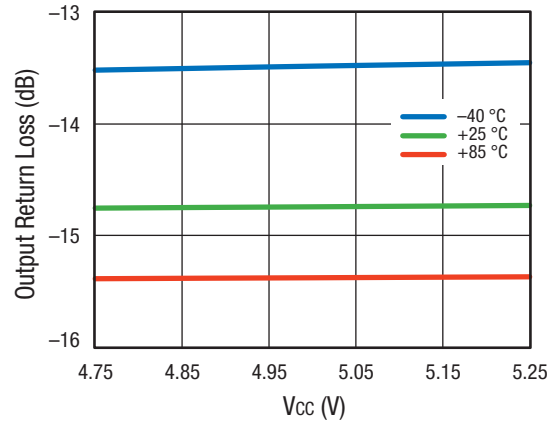


Figure 83. Output Return Loss vs VCC Across Temperature

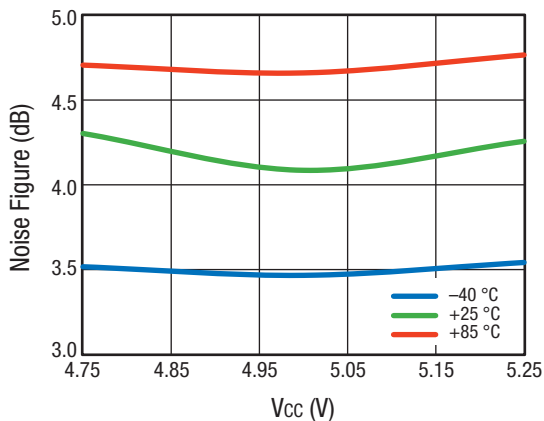


Figure 84. Noise Figure vs. VCC Across Temperature

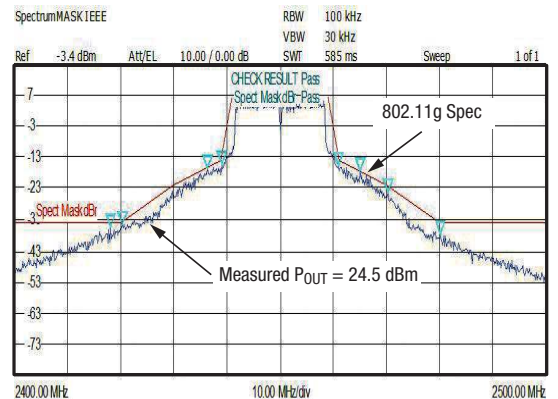
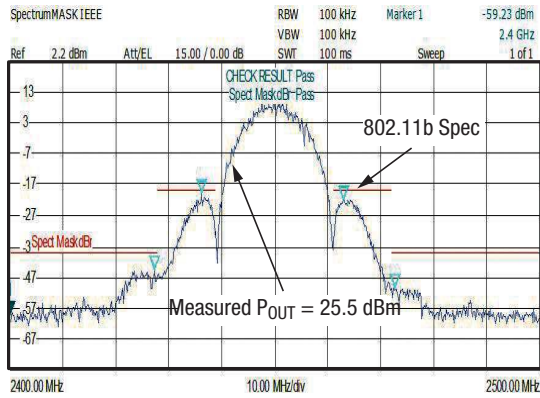
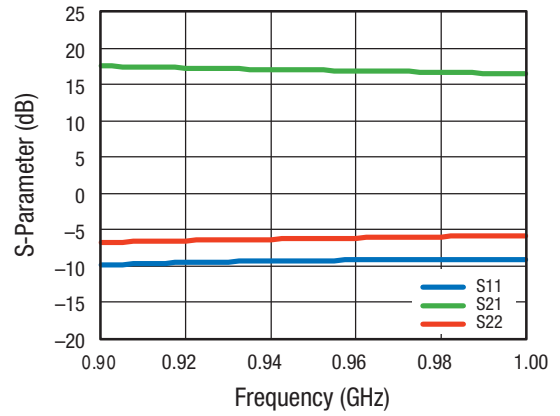


Figure 85. Spectral Response (802.11g 64 QAM at 54 Mbps Input Signal)

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**Figure 86. . Spectral Response
(802.11b 64 CCK at 11 Mbps Input Signal)**



**Figure 87. S-Parameter vs Frequency T = 25°C
Tuned for 900 MHz**

Typical Performance Data

(VCC = 5 V, MHz, CW, Output Impedance = 50 Ω, Tc = 25 °C, Unless Otherwise Noted)

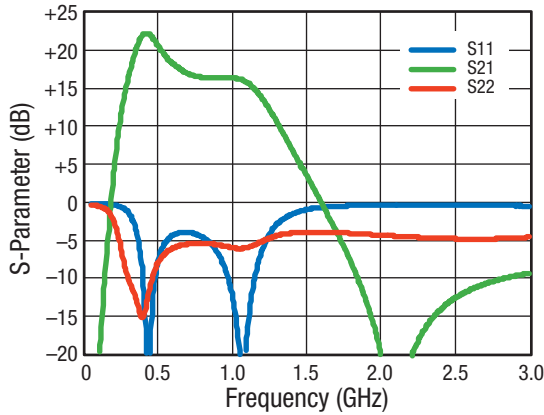


Figure 88. S-Parameter vs Frequency, Tuned for 450 MHz

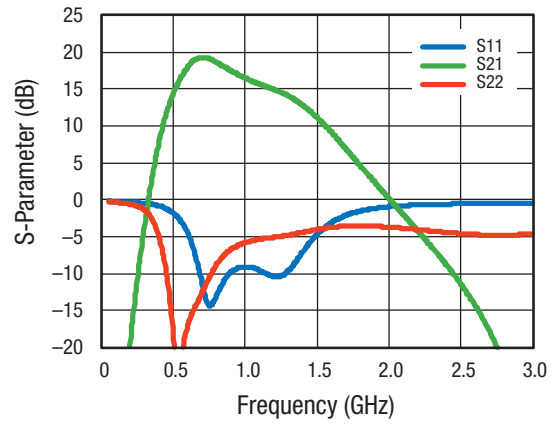


Figure 89. S-Parameter vs Frequency, Tuned for 900 MHz

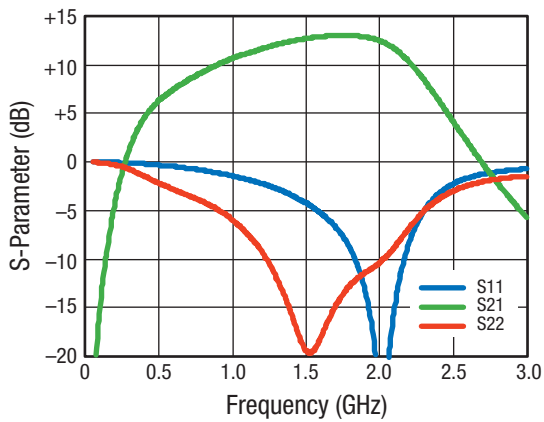


Figure 90. S-Parameter vs Frequency, Tuned for 1960 MHz

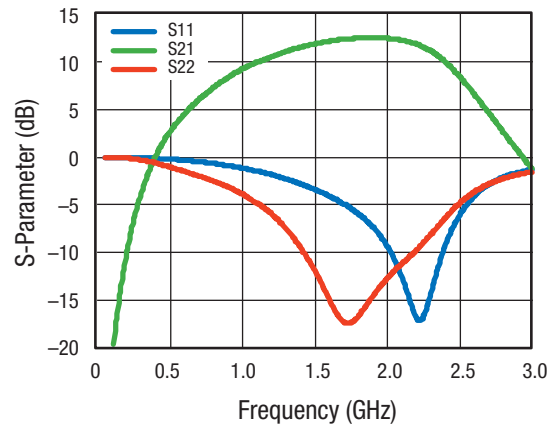


Figure 91. S-Parameter vs Frequency, Tuned for 2140 MHz

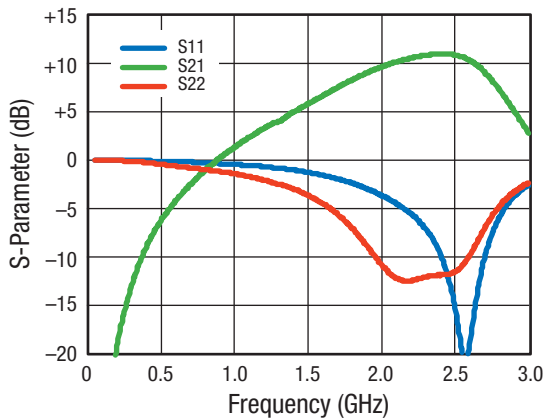


Figure 92. S-Parameters vs Frequency, Tuned for 2450 MHz